



# Effect of GaN buffer polarization on electron distribution of AlGaIn/GaN heterostructure



Xiaoguang He, Degang Zhao\*, Wei Liu, Jing Yang, Xiaojing Li, Xiang Li

State Key Laboratory on Integrated Optoelectronics, Institute of Semiconductors, Chinese Academy of Sciences, P.O. Box 912, Beijing 100083, China

## ARTICLE INFO

### Article history:

Received 29 December 2015

Accepted 6 February 2016

Available online 8 February 2016

### Keywords:

GaN

HEMT

Polarization

2DEG

## ABSTRACT

The formation of 2DEG in AlGaIn/GaN heterostructure is discussed in detail. A misunderstanding about the 2DEG sheet density expression is clarified. It is predicted by theoretical analysis and validated by self-consistent Schrodinger–Poisson numerical simulation that under the force of GaN polarization, large amounts of electrons will accumulate at the GaN/substrate interface in AlGaIn/GaN/substrate HEMT structure.

© 2016 Elsevier B.V. All rights reserved.

## 1. Introduction

High electron mobility transistors (HEMTs) based on AlGaIn/GaN heterostructures have shown great potential in high-power and high-frequency applications [1]. Owing to improvements made during the last decades in both material quality and device processing, AlGaIn/GaN HEMTs have been improved significantly in both DC and RF performance. An accurate expression of the 2DEG sheet carrier concentration  $n_s$  is of great importance to the further understanding of AlGaIn/GaN HEMTs. There is an important and very much widely cited equation reported for calculating the 2DEG concentration  $n_s$  (see Eq. (1) in this article, which will be discussed later in detail). However, the meaning of “ $\sigma$ ” in this formula is confusing and has some logical contradictions. In this work, we carefully analyze the process of the 2DEG formation and provide a clear physical image of the AlGaIn/GaN heterostructure. The meaning of “ $\sigma$ ” in the formula should be reinterpreted.

## 2. About the “ $\sigma$ ”

The widely cited 2DEG sheet density expression is given as [2–4]:

$$n_s = \frac{\sigma}{q} - \frac{\epsilon}{q^2 d} (q\phi_b + E_f - \Delta E_c), \quad (1)$$

where  $\epsilon$  is the dielectric constant of AlGaIn,  $d$  is the AlGaIn layer thickness,  $q$  is the electron charge,  $\phi_b$  is the surface barrier height,  $E_f$  is the Fermi level,  $\Delta E_c$  is the conduction band offset between GaN and AlGaIn, as is shown in Fig. 1. By transposing, Eq. (1) can be changed into:

$$\frac{1}{q} (q\phi_b + E_f - \Delta E_c) = d \left( \frac{\sigma}{\epsilon} - \frac{qns}{\epsilon} \right). \quad (2)$$

According to Fig. 1, the potential drop of AlGaIn barrier layer can be expressed as:

$$q\Delta V_{AlGaIn} = q\phi_b + E_f - \Delta E_c. \quad (3)$$

Putting Eq. (3) into Eq. (2), we can get:

$$\frac{\Delta V_{AlGaIn}}{d} = \frac{\sigma}{\epsilon} - \frac{qns}{\epsilon}. \quad (4)$$

Eq. (4) indicates that the electric field in AlGaIn barrier layer is determined by two parallel plate capacitors, of which sheet charge density is  $\pm\sigma$  and  $\pm qns$  respectively.

The structural profile and charge distribution of a AlGaIn/GaN heterojunction is shown in Fig. 2. We can see that there are indeed two pairs of coupled sheet charges at the upper surface and the lower interface of AlGaIn: ①  $\sigma_s$  and  $-qns$ , ②  $\pm\sigma_{AlGaIn}$ .  $\sigma_s$  is the sheet charge density of ionized surface donors. It equals to the product of

\* Corresponding author.

E-mail address: [dgzha@red.semi.ac.cn](mailto:dgzha@red.semi.ac.cn) (D. Zhao).

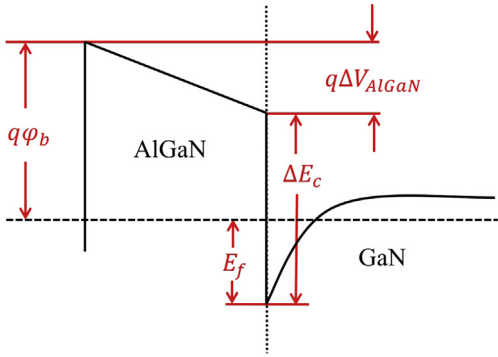


Fig. 1. Conduction band diagram of AlGaIn/GaN heterostructure.

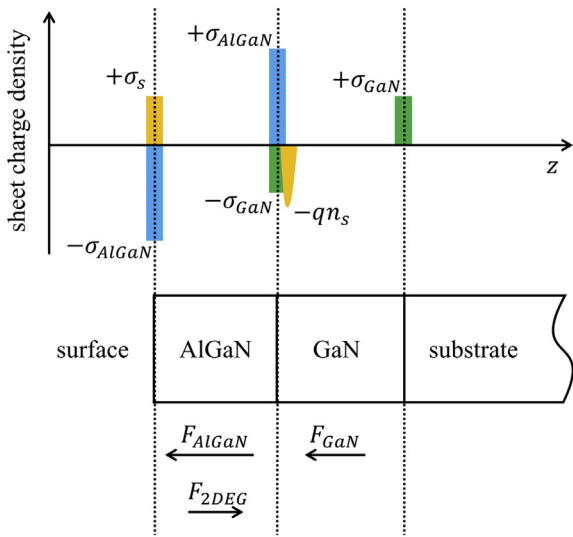


Fig. 2. Structure profile and charge distribution of AlGaIn/GaN/substrate heterostructure.

electron charge and the 2DEG sheet density  $qn_s$ , because the electrons in 2DEG is considered coming from the surface states of AlGaIn [5,6].  $\sigma_{AlGaIn}$  is the polarization charge sheet density of AlGaIn. Therefore, according to the above mentioned discussion, the “ $\sigma$ ” in Eq. (4) refers to the AlGaIn polarization charge density, i.e.,  $\sigma = \sigma_{AlGaIn}$ .

However, according to previous works [2–4,7–10] which have mentioned the 2DEG sheet density expression (Eq. (1)), the term “ $\sigma$ ” refers to the difference value of AlGaIn polarization charge and GaN polarization charge, i.e.,  $\sigma = \sigma_{AlGaIn} - \sigma_{GaN}$ . This argument makes the formula conforms to the result of experiment well, but has some logical contradictions. Admittedly, the net polarization charge sheet density at the AlGaIn/GaN interface is  $\sigma_{net} = \sigma_{AlGaIn} - \sigma_{GaN}$ . However, if  $\sigma = \sigma_{AlGaIn} - \sigma_{GaN}$ , according to Eq. (4), the absolute value of net polarization charge density at the AlGaIn upper surface should be equal to  $\sigma_{AlGaIn} - \sigma_{GaN}$ , too. But this is obviously contradictory to the fact that the only polarization charge at the AlGaIn surface is  $-\sigma_{AlGaIn}$ . There is not a “ $+\sigma_{GaN}$ ” at the AlGaIn surface. Moreover, it should be noticed that there is a positive polarization charge  $+\sigma_{GaN}$  at the GaN/substrate interface, as is shown in Fig. 2.  $\pm\sigma_{GaN}$  at the upper and lower interface of GaN layer form a parallel plate capacitor, which will only have nonzero electric field outside the GaN buffer layer. This means that polarization charge of GaN buffer will have no affect on the potential drop of AlGaIn barrier layer.

Actually, in previous works, polarization effect of GaN buffer is neglected when calculating the band diagram. Polarization sheet charge density of AlGaIn is considered as the relative value comparing with GaN's:  $\sigma_{AlGaIn} - \sigma_{GaN}$ , and polarization charge of GaN is regarded as zero. But why?

### 3. New calculation

Taking polarization effect of GaN buffer into consideration, there will be a polarization field  $F_{GaN}$  in GaN layer pointing from bottom to the top. Adding the potential drop caused by this electric field, the conduction band diagram should be like the one shown in Fig. 3, but not the one in Fig. 1. Moreover, we should notice that all the above-mentioned discussion is based on an *a priori* assumption that the 2DEG locates at the AlGaIn/GaN interface. In fact, charge distribution shown in Fig. 2 is not stable, because that electrons will move towards the GaN/substrate interface under the force of  $F_{GaN}$ , rather than fix at the AlGaIn/GaN interface.

The conduction band diagram and the corresponding electron distribution of a 20 nm  $Al_{0.25}Ga_{0.75}$ /20 nm GaN/substrate HEMT structure is calculated by self-consistent Schrodinger–Poisson numerical simulation, as is shown in Fig. 4a. The lattice parameter  $a$ , polarization intensity of  $P_{sp}$ ,  $P_{pz}$ ,  $P_{total}$  of GaN and AlGaIn that we used in the calculation are shown in Table 1. Here we only discuss under an assumption that the substrate material has a higher conduction band minimum than GaN's (e.g., sapphire). Since the specific band structure of substrate does not affect the electron distribution much, the conduction band edge of substrate is artificially set as 3 eV higher than GaN's. According to our calculation, electrons not only accumulate at the AlGaIn/GaN interface, there is also another electron distribution peak at the GaN/buffer interface. It is found that the width of GaN buffer affect neither the shape of the two electron peaks nor the shape of conduction band near the two interfaces. As long as the polarization of GaN is taken into consideration, electrons will move toward the substrate, and as long as the substrate has a higher conduction band edge than GaN, electrons will accumulate at the GaN/substrate interface. The band diagram and electron distribution of a HEMT structure with 40 nm GaN buffer is shown in Fig. 4b as an example. Therefore, for definiteness and without loss of generality, we will only discuss the characteristics of the HEMT structure with 20 nm GaN buffer in the following discussion.

Comparing with conventional works, the only difference of our calculation is that polarization of AlGaIn and GaN is set as the original value, i.e.,  $\sigma_{AlGaIn}$  and  $\sigma_{GaN}$  respectively. For comparison, band diagram and electron distribution of a 20 nm AlGaIn/20 nm GaN/20 nm substrate HEMT structure is also calculated under conventional conditions, i.e., polarization sheet charge density of AlGaIn and GaN is considered as  $\sigma_{AlGaIn} - \sigma_{GaN}$  and 0 respectively, as is shown in Fig. 4c. It can be found that Fig. 4a and c are almost the same at the region of 0–30 nm. They have very similar band diagram and electron distribution shape. The electron sheet density of 20 nm AlGaIn/20 nm GaN/substrate structure from 0 to 30 nm, i.e. the integral intensity of the first electron distribution peak, is

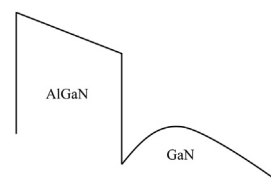


Fig. 3. Conduction band profile of AlGaIn/GaN heterojunction when taking polarization effect of GaN buffer into consideration.

Download English Version:

<https://daneshyari.com/en/article/1606302>

Download Persian Version:

<https://daneshyari.com/article/1606302>

[Daneshyari.com](https://daneshyari.com)